

# 2SK1089

## F-III Series

### > Features

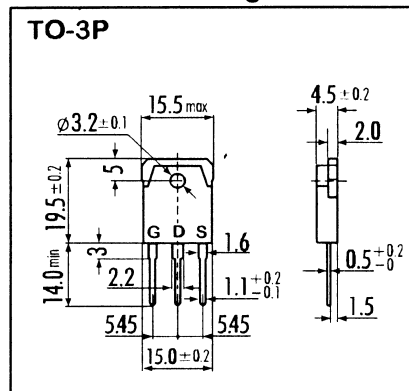
- High Current
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Forward Transconductance

N-channel MOS-FET			
60V	0,035Ω	35A	80W

### > Applications

- Motor Control
- General Purpose Power Amplifier
- DC-DC converters

### > Outline Drawing

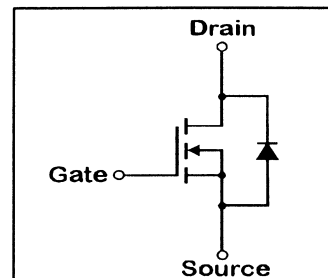


### > Maximum Ratings and Characteristics

- Absolute Maximum Ratings (T<sub>C</sub>=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V <sub>DS</sub>	60	V
Continuous Drain Current	I <sub>D</sub>	35	A
Pulsed Drain Current	I <sub>D(puls)</sub>	140	A
Continuous Reverse Drain Current	I <sub>DR</sub>	35	A
Gate-Source-Voltage	V <sub>GS</sub>	±20	V
Max. Power Dissipation	P <sub>D</sub>	80	W
Operating and Storage Temperature Range	T <sub>ch</sub>	150	°C
	T <sub>stg</sub>	-55 ~ +150	°C

### > Equivalent Circuit



- Electrical Characteristics (T<sub>C</sub>=25°C), unless otherwise specified

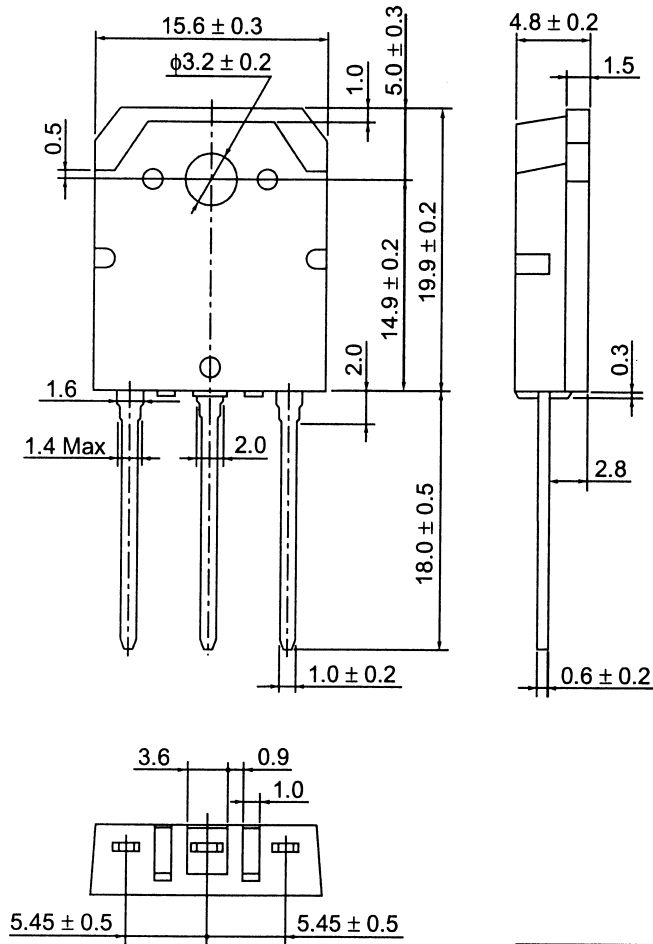
Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> =1mA V <sub>GS</sub> =0V	60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =1mA V <sub>DS</sub> =V <sub>GS</sub>	1,0	1,5	2,5	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V T <sub>ch</sub> =25°C		10	500	μA
		V <sub>GS</sub> =0V T <sub>ch</sub> =125°C		0,2	1,0	mA
Gate Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V V <sub>DS</sub> =0V		10	100	nA
Drain Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =17,5A V <sub>GS</sub> =4V		0,037	0,056	Ω
		I <sub>D</sub> =17,5A V <sub>GS</sub> =10V		0,025	0,035	Ω
Forward Transconductance	g <sub>fs</sub>	I <sub>D</sub> =17,5A V <sub>DS</sub> =25V	10	18		S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V		1800	2700	pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> =0V		620	930	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f=1MHz		240	360	pF
Turn-On-Time t <sub>on</sub> (t <sub>on</sub> =t <sub>d(on)</sub> +t <sub>r</sub> )	t <sub>d(on)</sub>	V <sub>CC</sub> =30V		6	9	ns
		I <sub>D</sub> =35A		60	90	ns
Turn-Off-Time t <sub>off</sub> (t <sub>off</sub> =t <sub>d(off)</sub> +t <sub>f</sub> )	t <sub>d(off)</sub>	V <sub>GS</sub> =10V		350	530	ns
		R <sub>GS</sub> =25 Ω		150	230	ns
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =2xI <sub>DR</sub> V <sub>GS</sub> =0V T <sub>ch</sub> =25°C		1,35	2,0	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =I <sub>DR</sub> V <sub>GS</sub> =0V -di <sub>F</sub> /dt=100A/μs T <sub>ch</sub> =25°C		200		ns

- Thermal Characteristics

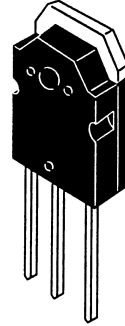
Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	R <sub>th(ch-a)</sub>	channel to air			35	°C/W
	R <sub>th(ch-c)</sub>	channel to case			1,56	°C/W



## Package Dimensions



As of January, 2001  
Unit: mm



Hitachi Code	TO-3P
JEDEC	—
EIAJ	Conforms
Mass (reference value)	5.0 g